

## STP10LN80K5

# N-channel 800 V, 0.55 Ω typ., 8 A MDmesh™ K5 Power MOSFET in a TO-220 package

Datasheet - production data

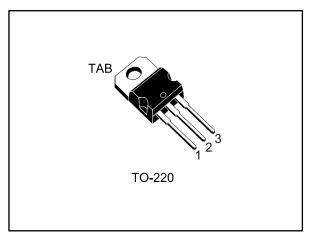
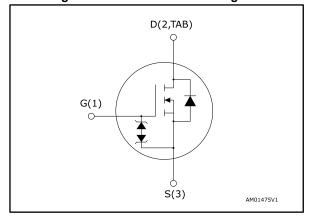


Figure 1: Internal schematic diagram



#### **Features**

Order code	e V <sub>DS</sub> R <sub>DS(on)</sub> max.		I <sub>D</sub>
STP10LN80K5	800 V	0.63 Ω	8 A

- Industry's lowest R<sub>DS(on)</sub> x area
- Industry's best figure of merit (FoM)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

### **Applications**

• Switching applications

### **Description**

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

**Table 1: Device summary** 

Order code	Marking	Package	Packing
STP10LN80K5	10LN80K5	TO-220	Tube

Contents STP10LN80K5

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STP10LN80K5 Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate-source voltage	± 30	V
$I_D$	Drain current (continuous) at T <sub>C</sub> = 25 °C	8	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	5	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	32	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	110	W
dv/dt (2)	Peak diode recovery voltage slope	4.5	\
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
T <sub>j</sub>	Operating junction temperature	FF to 150	°C
T <sub>stg</sub>	Storage temperature	- 55 to 150	

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	1.14	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	62.5	°C/W

**Table 4: Avalanche characteristics** 

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{\text{jmax}}$ )	2.7	А
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j$ = 25 °C, $I_D$ = $I_{AR}$ , $V_{DD}$ = 50 V)	240	mJ

 $<sup>^{(1)}</sup>$ Pulse width limited by safe operating area

 $<sup>^{(2)}</sup>I_{SD} \leq 8$  A, di/dt 100 A/ $\mu$ s; V $_{DS}$  peak < V $_{(BR)DSS}$ , V $_{DD}$ = 640 V

 $<sup>^{(3)}</sup>V_{DS} \le 640 \text{ V}$ 

Electrical characteristics STP10LN80K5

### 2 Electrical characteristics

T<sub>C</sub> = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_{D} = 1 \text{ mA}$	800			V
		$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$			1	μΑ
I <sub>DSS</sub>	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ $T_{C} = 125 \text{ °C}$			50	μΑ
I <sub>GSS</sub>	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DD} = V_{GS}$ , $I_D = 100 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 4 \text{ A}$		0.55	0.63	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		ı	427	-	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	ı	43	-	pF
$C_{rss}$	Reverse transfer capacitance	VG3 - 0 V	-	0.25	-	pF
C <sub>o(tr)</sub> <sup>(1)</sup>	Equivalent capacitance time related	V <sub>DS</sub> = 0 to 640 V,	1	72	-	pF
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	$V_{GS} = 0 V$		27	-	pF
$R_g$	Intrinsic gate resistance	$f = 1 \text{ MHz}$ , $I_D = 0 \text{ A}$	ı	7	-	Ω
$Q_g$	Total gate charge	$V_{DD} = 640 \text{ V}, I_D = 8 \text{ A}$	-	15	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 10 V	-	4.2	-	nC
$Q_{gd}$	Gate-drain charge	See Figure 16: "Test circuit for gate charge behavior"	-	9	-	nC

#### Notes:

**Table 7: Switching times** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD}$ = 400 V, $I_{D}$ = 4 A, $R_{G}$ = 4.7 $\Omega$	ı	11.8	1	ns
t <sub>r</sub>	Rise time	V <sub>GS</sub> = 10 V	ı	10	1	ns
t <sub>d(off)</sub>	Turn-off delay time	See Figure 15: "Test circuit for resistive load switching times"	ı	28	1	ns
t <sub>f</sub>	Fall time	and Figure 20: "Switching time waveform"	-	13	-	ns



 $<sup>^{(1)}</sup>$ Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 

 $<sup>^{(2)}</sup>$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		8	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		32	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 8 A, V <sub>GS</sub> = 0 V	-		1.5	V
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 8 \text{ A, di/dt} = 100 \text{ A/µs,V}_{DD} =$	-	350		ns
Q <sub>rr</sub>	Reverse recovery charge	60 V See Figure 17: "Test circuit for inductive load switching and diode recovery times"	-	3.9		μC
I <sub>RRM</sub>	Reverse recovery current		-	22.5		Α
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 8 A, di/dt = 100 A/µs V <sub>DD</sub> =	-	505		ns
Q <sub>rr</sub>	Reverse recovery charge	60 V, T <sub>i</sub> = 150 °C See Figure 17: "Test circuit for inductive load switching and diode recovery times"	-	5		μC
I <sub>RRM</sub>	Reverse recovery current		-	20		А

#### Notes:

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	$I_{GS}$ = ± 1mA, $I_{D}$ = 0 A	30		1	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

<sup>&</sup>lt;sup>(1)</sup>Pulse width limited by safe operating area

 $<sup>^{(2)}</sup>$ Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

## 2.2 Electrical characteristics (curves)

Figure 2: Safe operating area GIPG231120151312SOA (A) Operation in this area is limited by R<sub>DS(on)</sub> 10 t ₀=10 μs t p=100 µs t p=1 ms 10<sup>0</sup> T<sub>≤</sub>150 °C t <sub>0</sub>=10 ms T<sub>o</sub>= 25°C single pulse 10<sup>-1</sup>  $\overline{V}_{DS}(V)$ 10<sup>-1</sup> 10° 10<sup>1</sup> 10<sup>2</sup>  $10^{3}$ 

Figure 3: Thermal impedance  $\begin{array}{c} \kappa \\ \delta = 0.5 \\ \hline \delta = 0.2 \\ \hline \delta = 0.1 \\ \hline 10^{-1} \\ \hline \\ \delta = 0.02 \\ \hline \\ \delta = 0.02 \\ \hline \\ \delta = 0.02 \\ \hline \\ \delta = 0.01 \\ \hline \\ SINGLE PULSE \\ \hline \\ 10^{-5} \\ \hline \\ 10^{-4} \\ \hline \\ 10^{-3} \\ \hline \\ 10^{-1} \\ \hline \\ t_p(s) \\ \hline \end{array}$ 

Figure 4: Output characteristics

GIPG231120151325OCH

(A)

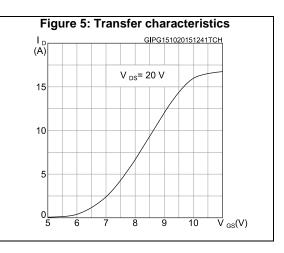
V<sub>GS</sub>= 10 V

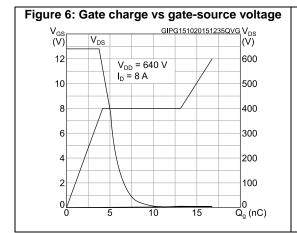
V<sub>GS</sub>= 9 V

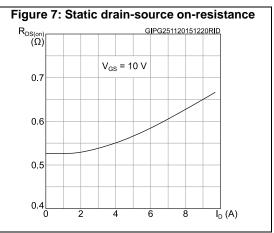
V<sub>GS</sub>= 7 V

V<sub>GS</sub>= 6 V

0 4 8 12 16 V<sub>DS</sub> (V)







STP10LN80K5 Electrical characteristics

Figure 8: Capacitance variations C (pF) GIPG151020151325CVR 10<sup>3</sup> C<sub>ISS</sub> 10<sup>2</sup> f = 1 MHz Coss 10<sup>1</sup>  $C_{\text{RSS}}$ 10 º 10<sup>-1</sup> ∇ <sub>DS</sub>(V) 10<sup>-1</sup> 10<sup>1</sup>  $10^{2}$ 

Figure 10: Normalized on-resistance vs temperature

R<sub>DS(on)</sub> GIPG151020151154RON

(norm.)

2.6 V<sub>GS</sub> = 10 V

2.2

1.8

1.4

1.0

0.6

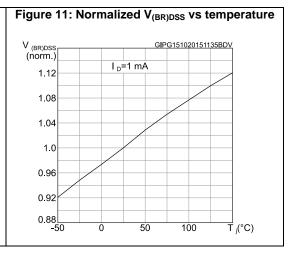
0.2

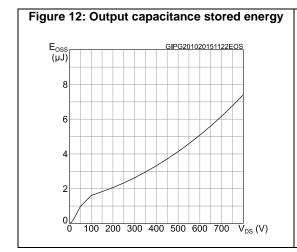
-50

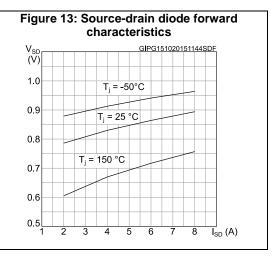
0 50

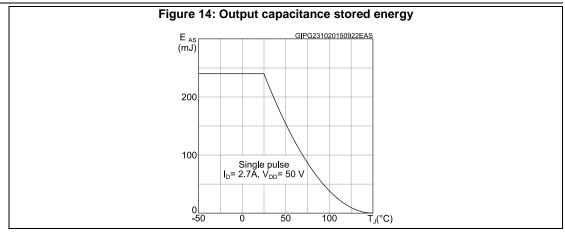
100

T<sub>j</sub> (°C)









STP10LN80K5 Test circuits

### 3 Test circuits

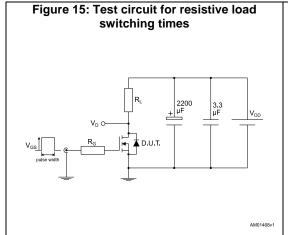


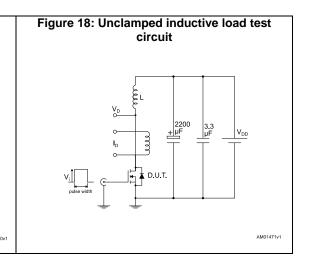
Figure 16: Test circuit for gate charge behavior

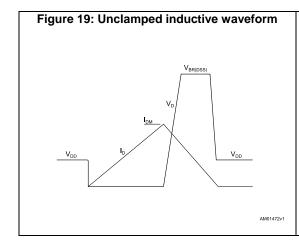
12 V 47 kΩ 100 nF 1 kΩ

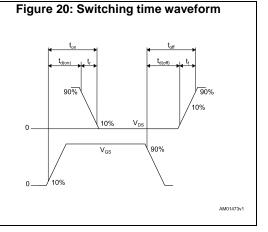
Vos 16 CONST 100 nF 1 kΩ

AM01466y1

Figure 17: Test circuit for inductive load switching and diode recovery times







# 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

STP10LN80K5 Package information

# 4.1 TO-220 type A package information

Figure 21: TO-220 type A package outline

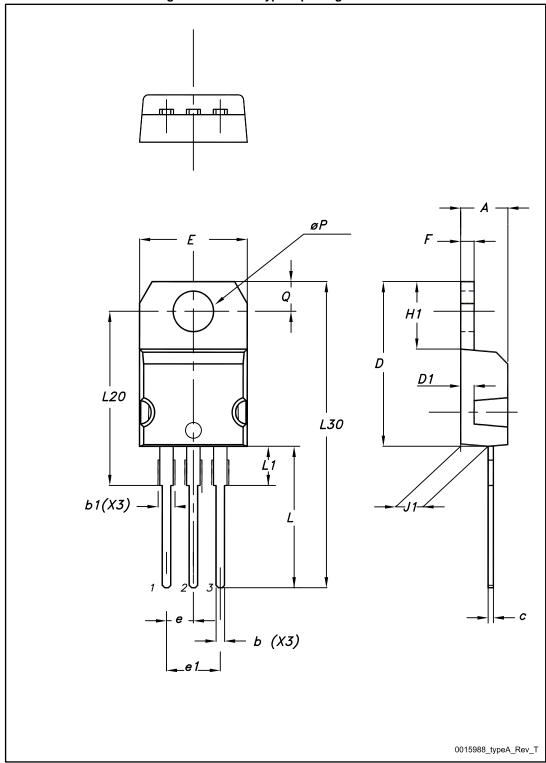


Table 10: TO-220 type A mechanical data

Dim	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
Е	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
øΡ	3.75		3.85
Q	2.65		2.95

STP10LN80K5 Revision history

# 5 Revision history

Table 11: Document revision history

Date	Revision	Changes
10-Jun-2015	1	First release.
14-Dec-2015	2	Datasheet promoted from preliminary data to production data  Modified: Table 2: "Absolute maximum ratings", Table 3: "Thermal data", Table 4: "Avalanche characteristics", Table 5: "On/off-state", Table 6: "Dynamic", Figure 2: "Safe operating area", Figure 3: "Thermal impedance", Figure 4: "Output characteristics" and Figure 7: "Static drain-source on-resistance"  Minor text changes

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